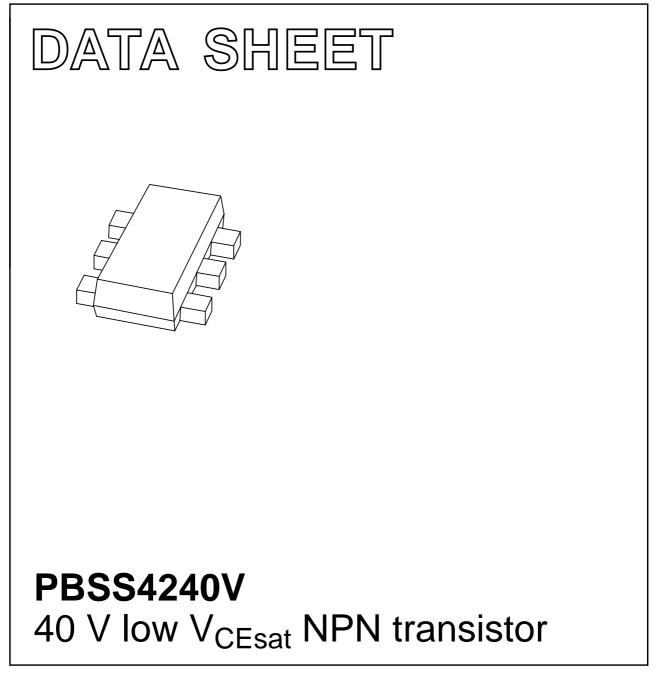
DISCRETE SEMICONDUCTORS



Product specification

2003 Jan 30



HILIP

PBSS4240V

FEATURES

- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability I_{C} and I_{CM}
- High collector current gain (h_{FE}) at high I_C
- · High efficiency leading to reduced heat generation
- Reduced printed-circuit board area requirements.

APPLICATIONS

- Power management:
 - DC-DC converter
 - Supply line switching
 - Battery charger
 - LCD back lighting.
- Peripheral driver:
 - Driver in low supply voltage applications (e.g. lamps and LEDs)
 - Inductive load drivers (e.g. relay, buzzers and motors).

DESCRIPTION

NPN transistor providing low V_{CEsat} and high current capability in a SOT666 plastic package. PNP complement: PBSS5240V.

MARKING

TYPE NUMBER	MARKING CODE		
PBSS4240V	42		

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V _{CEO}	collector-emitter voltage	40	V
I _C	collector current (DC)		A
I _{CRP}	RP peak collector current		А
R _{CEsat}	equivalent on-resistance <190 n		mΩ

PINNING

PIN	DESCRIPTION	
1	collector	
2	collector	
3	base	
4	emitter	
5	collector	
6	collector	

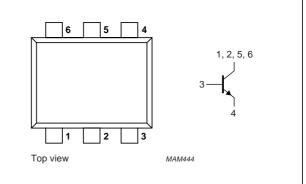


Fig.1 Simplified outline (SOT666) and symbol.

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER CONDITIONS		MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	-	40	V
V _{CEO}	collector-emitter voltage	open base	-	40	V
V _{EBO}	emitter-base voltage	open collector	-	5	V
I _C	collector current (DC)	note 1	-	2	A
I _{CRP}	repetitive peak collector current	note 2	-	2	A
I _{CM}	peak collector current		-	3	A
I _B	base current (DC)		-	300	mA
I _{BM}	peak base current		-	1	A
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 3	-	300	mW
		$T_{amb} \le 25 \ ^{\circ}C$; note 4	-	500	mW
		$T_{amb} \le 25 \ ^{\circ}C$; note 1	-	900	mW
		$T_{amb} \le 25 \ ^{\circ}C$; notes 2 and 3	-	1.2	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Notes

- 1. Device mounted on a ceramic circuit board, AI_2O_3 , standard footprint.
- 2. Operated under pulsed conditions: duty cycle δ \leq 20%, pulse width t_{p} \leq 30 ms.
- 3. Device mounted on a printed-circuit board, single-sided copper, tinplated, standard footprint.
- 4. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1 cm².

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to	note 1	410	K/W
	ambient	note 2	215	K/W
		note 3	140	K/W
		notes 1 and 4	110	K/W

Notes

- 1. Device mounted on a printed-circuit board, single-sided copper, tinplated, standard footprint.
- 2. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1 cm².
- 3. Device mounted on a ceramic circuit board, Al₂O₃, standard footprint.
- 4. Operated under pulsed conditions: duty cycle δ \leq 20%, pulse width t_p \leq 30 ms.

Soldering

The only recommended soldering method is reflow soldering.

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CHARACTERISTICS

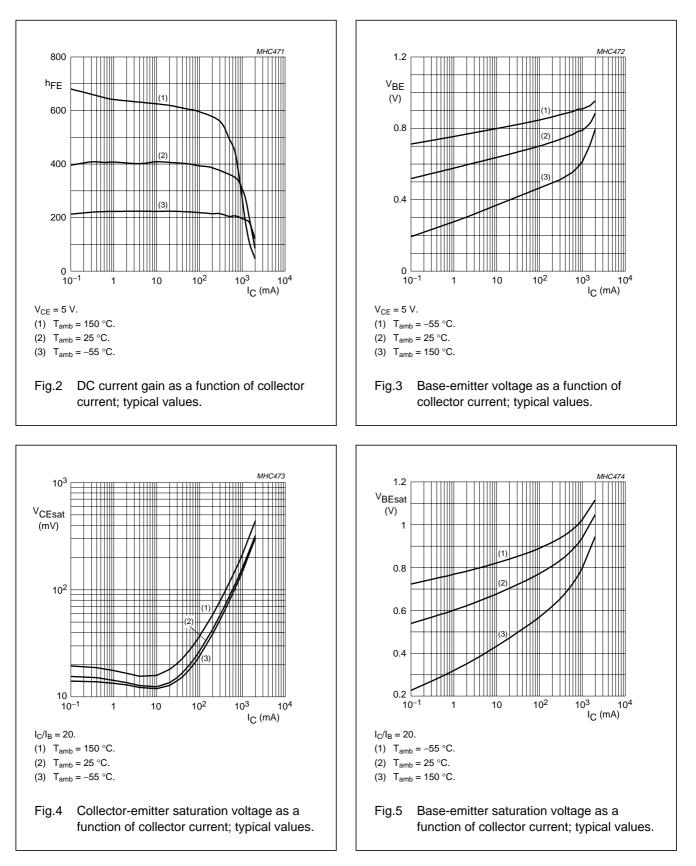
 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	$V_{CB} = 40 \text{ V}; \text{ I}_{E} = 0$	-	-	100	nA
		$V_{CB} = 40 \text{ V}; \text{ I}_{E} = 0; \text{ T}_{amb} = 150 ^{\circ}\text{C}$	-	-	50	μA
I _{CEO}	collector-emitter cut-off current	$V_{CE} = 30 \text{ V}; \text{ I}_{B} = 0$	-	_	100	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 V; I_{C} = 0$	-	-	100	nA
h _{FE}	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 1 \text{ mA}$	300	-	-	
		$V_{CE} = 5 \text{ V}; \text{ I}_{C} = 500 \text{ mA}$	300	-	900	
		V _{CE} = 5 V; I _C = 1 A	200	-	-	
		$V_{CE} = 5 \text{ V}; I_{C} = 2 \text{ A}; \text{ note } 1$	75	-	-	
V _{CEsat}	collector-emitter saturation voltage	I _C = 100 mA; I _B = 1 mA	-	50	75	mV
		I _C = 500 mA; I _B = 50 mA	-	70	100	mV
		I _C = 1 A; I _B = 100 mA; note 1	-	150	190	mV
		I _C = 2 A; I _B = 200 mA; note 1	-	300	400	mV
R _{CEsat}	equivalent on-resistance	I _C = 1 A; I _B = 100 mA; note 1	-	150	<190	mΩ
V _{BEsat}	base-emitter saturation voltage	I _C = 1 A; I _B = 100 mA	-	-	1.2	V
V _{BEon}	base-emitter turn-on voltage	$V_{CE} = 5 \text{ V}; \text{ I}_{C} = 1 \text{ A}$	-	-	1.1	V
f _T	transition frequency	I _C = 50 mA; V _{CE} = 10 V; f = 100 MHz	150	-	-	MHz
C _c	collector capacitance $V_{CB} = 10 \text{ V}; \text{ I}_{E} = \text{ I}_{e} = 0; \text{ f}$		-	-	10	pF

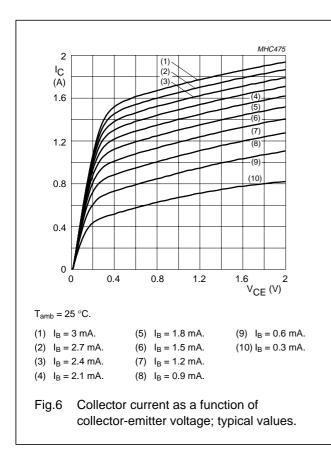
Note

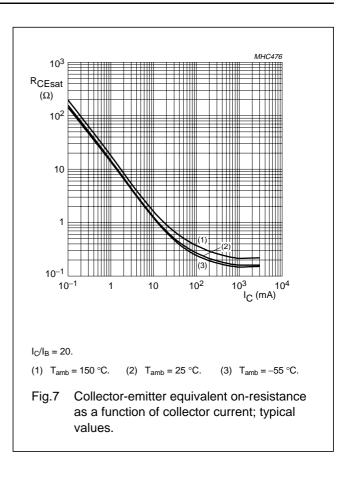
1. Pulse test: $t_p \leq 300 \ \mu s; \ \delta \leq 0.02.$

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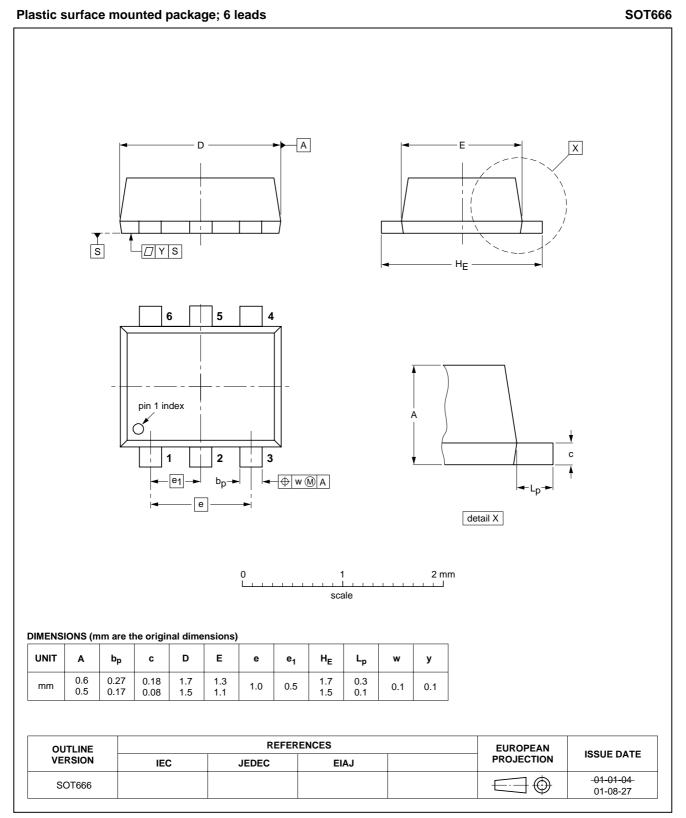




PBSS4240V

40 V low V_{CEsat} NPN transistor

PACKAGE OUTLINE



PBSS4240V

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾⁽³⁾	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
11	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

Notes

- 1. Please consult the most recently issued data sheet before initiating or completing a design.
- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Printed in The Netherlands

613514/01/pp**12**

Date of release: 2003 Jan 30

Document order number: 9397 750 10782

SCA75

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